

October 2007

# FSA2269 / FSA2269TS — Low-Voltage Dual-SPDT (0.4 $\Omega$ ) Analog Switch with Negative Swing Audio Capability

## **Features**

- 0.4Ω Typical On Resistance (R<sub>ON</sub>) for +3.0V Supply
- 0.25Ω Maximum R<sub>ON</sub> Flatness for +3.0V Supply
- -3db Bandwidth: > 50MHz
- Low-I<sub>CCT</sub> Current Over an Expanded Control Input Range
- Packaged in Pb-free 10-Lead MicroPak<sup>™</sup> and UMLP
- Power-Off Protection on Common Ports
- Broad V<sub>CC</sub> Operating Range: 1.65 to 4.3V
- Noise Immunity Termination Resistors in FSA2269TS

# **Applications**

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

# **Description**

The FSA2269 is a high-performance, dual Single-Pole Double-Throw (SPDT) analog switch with negative swing audio capability. The FSA2269 features ultra-low  $R_{\text{ON}}$  of  $0.4\Omega$  (typical) at  $3.0V\ V_{\text{CC}}$ . The FSA2269 operates over a wide  $V_{\text{CC}}$  range of 1.65V to 4.3V, is fabricated with submicron CMOS technology to achieve fast switching speeds, and is designed for break-before-make operation. The select input is TTL-level compatible.

The FSA2269 features very low quiescent current even when the control voltage is lower than the V<sub>CC</sub> supply. This feature suits mobile handset applications by allowing direct interface with baseband processor general-purpose I/Os with minimal battery consumption.

The FSA2269TS includes termination resistors that improve noise immunity during overshoot excursions, off-isolation coupling, or "pop-minimization."

## **IMPORTANT NOTE:**

For additional performance information, please contact analogswitch@fairchildsemi.com.

# **Ordering Information**

Part Number	Top Mark	Package Description	
FSA2269L10X	HL	10-Lead, MicroPak, JEDEC MO-255, 1.6 x 2.1mm	
FSA2269UMX	HP	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4x1.8mm, 0.4mm pitch	
FSA2269TSL10X	HN	10-Lead, MicroPak, JEDEC MO-255, 1.6 x 2.1mm	
FSA2269TSUMX	HS	10-Lead, Quad Ultrathin Molded Leadless Package (UMLP), 1.4x1.8mm, 0.4mm pitch	

All packages are lead free per JEDEC: J-STD-020B standard.

# **Analog Symbols**

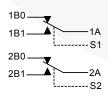


Figure 1. FSA2269

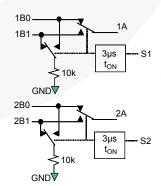


Figure 2. FSA2269TS (with Slow Turn On)





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## Definition of Terms

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